

FSA1259A

Low-Voltage, 1Ω Dual SPST Analog Switch with Power-Off Isolation

Features

- Power-Off Isolation ($V_{CC}=0V$)
- 1Ω On Resistance (R_{ON}) for 4.5V V_{CC}
- 0.25Ω Maximum R_{ON} Flatness for 4.5V V_{CC}
- Space-Saving, US8 Surface Mount Package
- Broad V_{CC} Operating Range: 1.65V to 5.50V
- Fast Turn-On and Turn-Off Times
- Break-Before-Make Enable Circuitry

Description

The FSA1259A is a high-performance, dual, Single-Pole / Single-Throw (SPST) analog switch. The device features ultra-low R_{ON} of 1Ω at 4.5V V_{CC} and operates over the wide V_{CC} range of 1.65V to 5.50V.

The FS1259A allows for reduced input thresholds on the select pins.

The device is fabricated with sub-micron CMOS technology to achieve fast switching speeds and is designed for break-before-make operation.

Applications

- Cellular Phone
- Portable Media Player
- PDA

Ordering Information

Part Number	Top Mark	Operating Temperature Range	Package	Packing Method
FSA1259AK8X	59A	-40°C to +85°C	8-Lead US8, JEDEC MO-187, Variation CA, 3.0mm Wide	3000 Units Tape and Reel

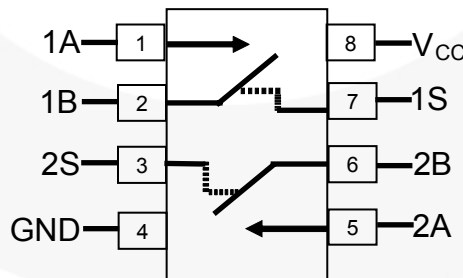


Figure 1. Analog Symbols

Pin Assignments

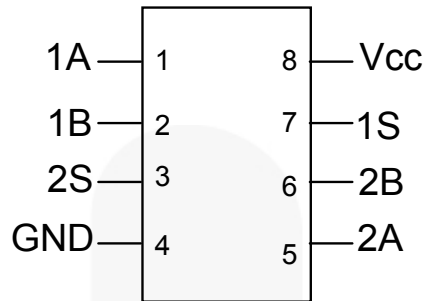


Figure 2. Pin Assignments (Top View)

Pin Definitions

Pin #	Name	Description
1	1A	Data Port
2	1B	Data Port
3	2S	Control Input
4	GND	Ground
5	2A	Data Port
6	2B	Data Port
7	1S	Control Input
8	V _{CC}	Supply Voltage

Truth Table

Control Input (S)	Function
LOW	Disconnected
HIGH	A Connected to B

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Min.	Max.	Unit
V _{CC}	Supply Voltage	-0.5	7.0	V
V _{SW}	Switch Voltage ⁽¹⁾	-0.5	V _{CC} +0.5	V
V _{IN}	Input Voltage ⁽¹⁾	-0.5	6.5	V
I _{IK}	Input Diode Current		-50	mA
I _{SW}	Switch Current (Continuous)		200	mA
I _{SWPEAK}	Peak Switch Current (Pulsed at 1ms Duration, <10% Duty Cycle)		400	mA
P _D	Power Dissipation at 85°C		3.0	μW
T _{STG}	Storage Temperature Range	-65	+150	°C
T _J	Maximum Junction Temperature		+150	°C
T _L	Lead Temperature (Soldering, 10 seconds)		+260	°C
ESD	Human Body Model (JEDEC: JESD22-A114)		8000	V
	Charged Device Model (JEDEC: JESD22-C101)		2000	V
	Machine Model (JEDEC: JESD22-A115)		350	V

Note:

- The input and output negative ratings may be exceeded if the input and output diode current ratings are observed.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Min.	Max.	Unit
V _{CC}	Supply Voltage	1.65	5.50	V
A _{SEL}	Control Input Voltage ⁽²⁾	0	V _{CC}	V
V _{SW}	Switch Input Voltage	0	V _{CC}	V
T _A	Operating Temperature	-40	+85	°C
θ _{JA}	Thermal Resistance, Still Air		215	°C/W

Note:

- Control Input must be held HIGH or LOW; it must not float.

Electrical Characteristics

All typical values are at 25°C unless otherwise specified.

Symbol	Parameter	V _{CC} (V)	Conditions	T _A =+25°C			T _A =-40 to +85°C		Unit
				Min.	Typ.	Max.	Min.	Max.	
V _{IH}	Input Voltage High	4.50 to 5.50					1.0		V
		3.00 to 3.60					1.0		
		2.30 to 2.70					0.95		
		1.65 to 1.95					0.95		
V _{IL}	Input Voltage Low	4.50 to 5.50						0.75	V
		3.00 to 3.60						0.65	
		2.30 to 2.70						0.55	
		1.65 to 1.95						0.5	
I _{IN}	Control Input Leakage	5.50	V _{IN} =0 or V _{CC}	-10		10	-50	50	nA
		3.60	V _{IN} =0 or V _{CC}	-2		2	-20	20	
		2.70	V _{IN} =0 or V _{CC}	-2		2	-20	20	
		1.95	V _{IN} =0 or V _{CC}	-2		2	-20	20	
I _{NO(OFF)}	Off-Leakage Current	5.50	A=1V, B=4.5V or B=4.5, A=1V	-10		10	-50	50	nA
		3.60	A=1V, B=4.5V or B=4.5, A=1V	-5		5	-50	50	
		2.70	A=0.5V, B=2.3V or B=2.3, A=0.5V	-5		5	-50	50	
		1.95	A=0.3V, B=1.65V or B=1.65, A=0.3V	-5		5	-50	50	
I _{NO(ON)}	On-Leakage Current of Port B	5.50	A=Floating; B=4.5V, 1V	-5		5	-50	50	nA
		3.60	A=Floating; B=3.0V, 1V	-2		2	-20	20	
		2.70	A=Floating; B=2.3V, 0.5V	-2		2	-20	20	
		1.95	A=Floating; B=1.65V, 0.3V	-2		2	-20	20	
I _{A(ON)}	On-Leakage Current of Port A	5.50	A=1V, 4.5V; B=Floating	-5		5	-50	50	nA
		3.60	A=1V, 3.0V; B=Floating	-2		2	-20	20	
		2.70	A=0.5V, 2.3; B=Floating	-2		2	-20	20	
		1.95	A=0.3V, 1.65V; B=Floating	-2		2	-20	20	
I _{OFF}	Power Off Leakage Current of Port A & Port B	0	A=0 to 5.5V; B=0 to 5.5V	-1		1	-10	10	μA

Electrical Characteristics (Continued)

All typical values are at 25°C unless otherwise specified.

Symbol	Parameter	V _{CC} (V)	Conditions	T _A =+25°C			T _A =-40 to +85°C		Unit
				Min.	Typ.	Max.	Min.	Max.	
R _{PEAK}	Peak On Resistance	4.50	I _{OUT} =-100mA, 1B or 2B=0 to V _{CC}		0.8	1.0		1.2	Ω
		3.00	I _{OUT} =-100mA, 1B or 2B=0 to V _{CC}		1.0	1.5		1.8	
		2.30	I _{OUT} =-8mA, 1B or 2B=0 to V _{CC}		1.5	2.0		2.5	
		1.65	I _{OUT} =-2mA, 1B or 2B=0 to V _{CC}	T _A =25, 85°C	5.0	12.0		15.0	
T _A =-40°C	20.0								
R _{ON}	Switch On Resistance ⁽³⁾	4.50	I _{OUT} =-100mA, 1B or 2B=2.5V		0.70	0.85		1.00	Ω
		3.00	I _{OUT} =-100mA, 1B or 2B=2.0V		0.9	1.3		1.6	
		2.30	I _{OUT} =-8mA, 1B or 2B=1.8V		1.4	2.0		2.4	
		1.65	I _{OUT} =-2mA, 1B or 2B=1.5V		2.0	2.5		3.5	
ΔR _{ON}	On Resistance Matching Between Channels ⁽⁴⁾	4.50	I _{OUT} =-100mA, 1B or 2B=2.5V		0.05	0.10		0.10	Ω
		3.00	I _{OUT} =-100mA, 1B or 2B=2.0V		0.10	0.15		0.15	
		2.30	I _{OUT} =-8mA, 1B or 2B=1.8V		0.15	0.20		0.20	
		1.65	I _{OUT} =-2mA, 1B or 2B=1.5V		0.15	0.40		0.40	
R _{FLAT(ON)}	On Resistance Flatness ⁽⁵⁾	4.50	I _{OUT} =-100mA, 1B or 2B=1.0V, 1.5V, 2.5V		0.10	0.25		0.25	Ω
		3.00	I _{OUT} =-100mA, 1B or 2B=0.8V, 2.0V		0.1	0.3		0.3	
		2.30	I _{OUT} =-8mA, 1B or 2B=0.8V, 1.8V		0.2	1.0		1.0	
		1.65	I _{OUT} =-2mA, 1B or 2B=0.6V, 1.5V		1.5				
I _{CC}	Quiescent Supply Current	5.50	V _{IN} =0 or V _{CC} , I _{OUT} =0		5	50		500	nA
		3.60	V _{IN} =0 or V _{CC} , I _{OUT} =0		1	25		300	
		2.70	V _{IN} =0 or V _{CC} , I _{OUT} =0		1	20		250	
		1.95	V _{IN} =0 or V _{CC} , I _{OUT} =0		1	15		150	
I _{CC(T)}	Increase in I _{CC} per Control Input	4.5 to 5.5	Asel=1.8V		25			40	μA

Notes:

3. On resistance is determined by the voltage drop between the A and B pins at the indicated current through the switch.
4. ΔR_{ON}=R_{ON} maximum – R_{ON} minimum; measured at identical V_{CC}, temperature, and voltage.
5. Flatness is defined as the difference between the maximum and minimum value of on resistance over the specified range of conditions.

AC Electrical Characteristics

All typical values are at $V_{CC}=1.8V, 2.5V, 3.0V, 5.0V$ at $25^{\circ}C$ unless otherwise specified.

Symbol	Parameter	V_{CC} (V)	Conditions	$T_A=+25^{\circ}C$			$T_A=-40to+85^{\circ}C$		Unit	Figure
				Min.	Typ.	Max.	Min.	Max.		
t_{ON}	Turn-On Time	4.50 to 5.50	1B or 2B= V_{CC} , $R_L=50\Omega$, $C_L=35pF$	1.0	4.0	7.5	1.0	9.0	ns	Figure 11
		3.00 to 3.60		1.5	6.0	9.5	1.0	10.0		
		2.30 to 2.70		2.0	8.0	10.0	1.0	12.0		
		1.65 to 1.95		3.0	14.0	18.0	1.0	20.0		
t_{OFF}	Turn-Off Time	4.50 to 5.50	1B or 2B= V_{CC} , $R_L=50\Omega$, $C_L=35pF$	4.5	13.0	17.0	3.5	20.0	ns	Figure 11
		3.00 to 3.60		4.5	13.5	17.0	3.0	20.0		
		2.30 to 2.70		4.5	16.0	20.0	3.0	23.0		
		1.65 to 1.95		5.0	24.0	33.0	4.0	36.0		
Q	Charge Injection	4.50 to 5.50	$C_L=1.0nF$, $V_{GEN}=0V$, $R_{GEN}=0\Omega$		15				pC	Figure 13
		3.00 to 3.60			11					
		2.30 to 2.70			8					
		1.65 to 1.95			6					
OIRR	Off-Isolation	1.8 to 5.0	$f=1MHz$, $R_L=50\Omega$		-60				dB	Figure 12
Xtalk	Crosstalk	1.8 to 5.0	$f=1MHz$, $R_L=50\Omega$		-73				dB	Figure 12
BW	-3db Bandwidth	4.50 to 5.50	$R_L=50\Omega$		240				MHz	Figure 15
		3.00 to 3.60			240					
		2.30 to 2.70			240					
		1.65 to 1.95			240					
THD	Total Harmonic Distortion	1.8	$R_L=600\Omega$, $V_{IN}=0.5V_{PP}$, $f=20Hz$ to $20kHz$.003				%	Figure 16
		5.0			.001					Figure 16

Capacitance

Symbol	Parameter	V_{CC} (V)	Conditions	$T_A=+25^{\circ}C$			Unit
				Min.	Typ.	Max.	
C_{IN}	Control Pin Input Capacitance	0	$f=1MHz$ Figure 14		3		pF
C_{OFF}	B Port Off Capacitance	1.65 to 5.50	$f=1MHz$ Figure 14		21		pF
C_{ON}	A Port On Capacitance	1.65 to 5.50	$f=1MHz$ Figure 14		47		pF

Typical Performance Characteristics

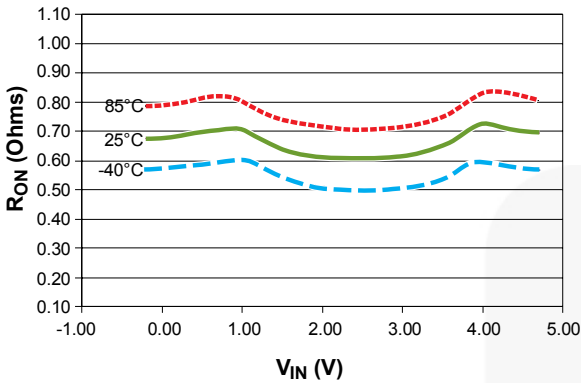


Figure 3. On Resistance ($V_{CC}=4.5V$)

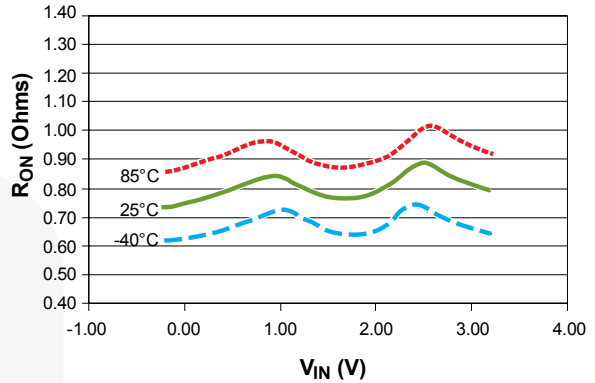


Figure 4. On Resistance ($V_{CC}=3.0V$)

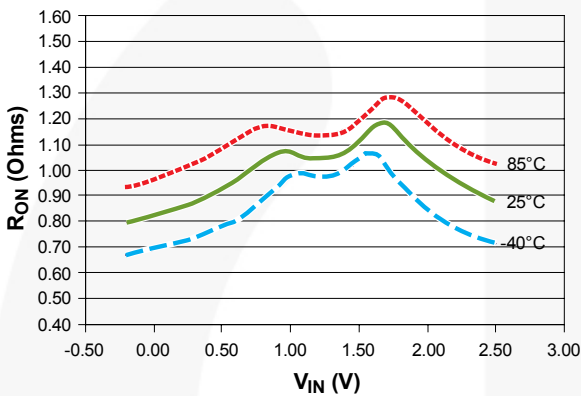


Figure 5. On Resistance ($V_{CC}=2.3V$)

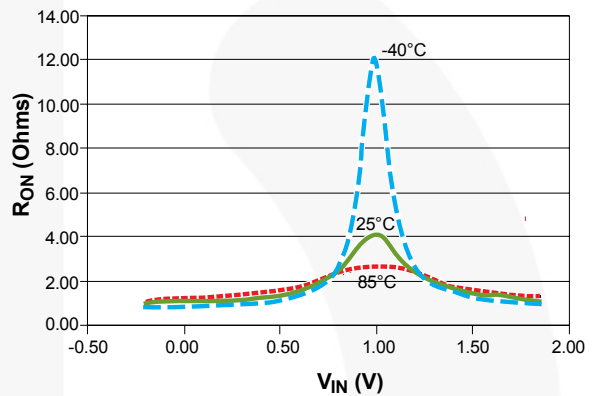


Figure 6. On Resistance ($V_{CC}=1.65V$)

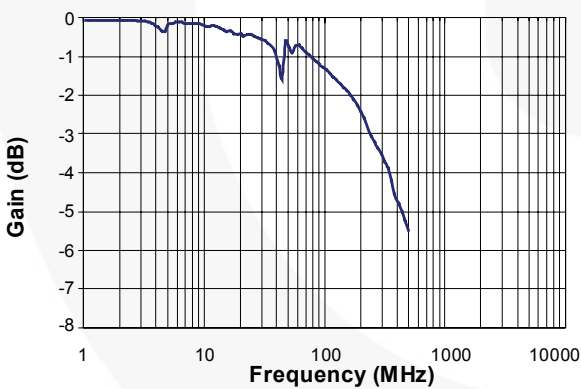


Figure 7. Frequency Response ($V_{CC}=5.5V, C_L=0pF$)

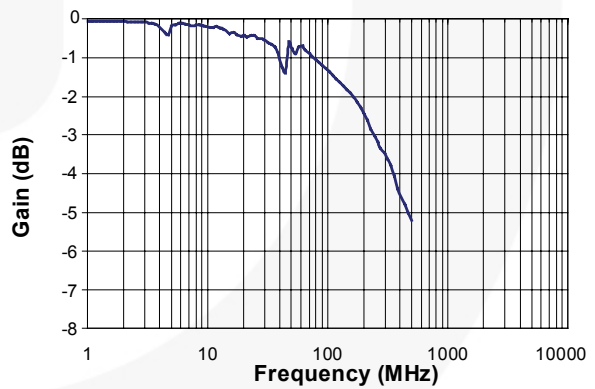


Figure 8. Frequency Response ($V_{CC}=3.3V, C_L=0pF$)

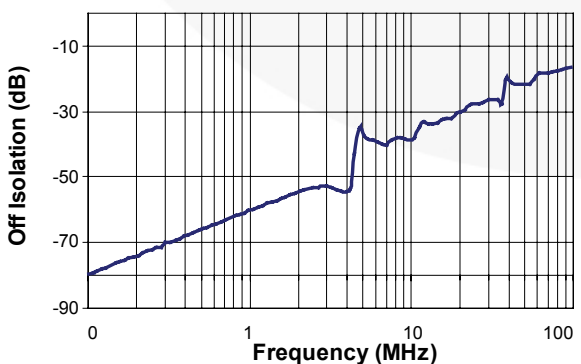


Figure 9. Frequency Response ($V_{CC}=5.0V, C_L=0pF$)

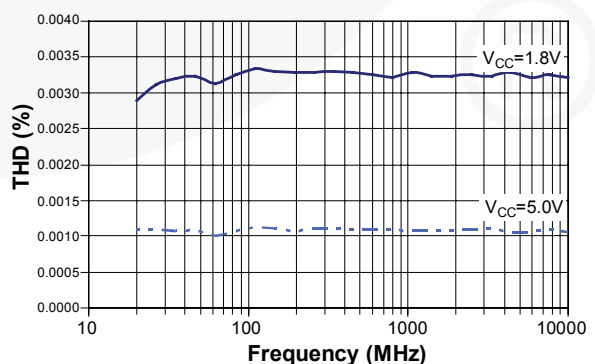


Figure 10. Total Harmonic Distortion

Test Diagrams

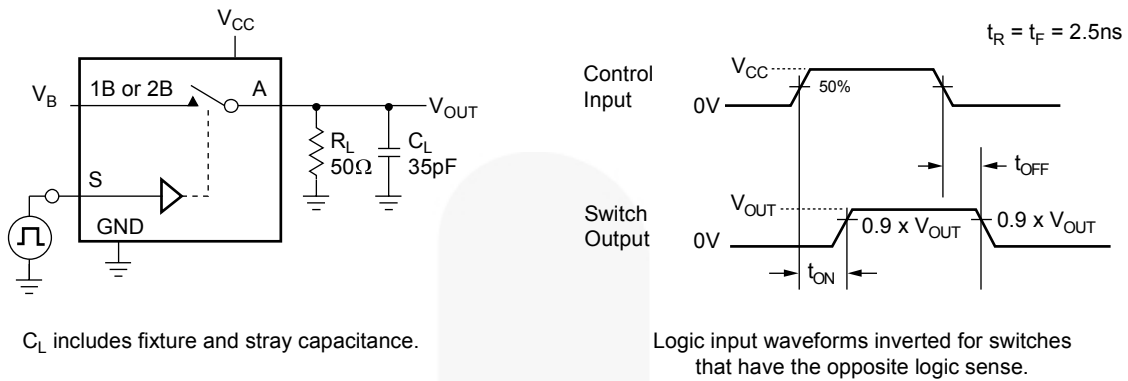


Figure 11. Turn On / Off Timing

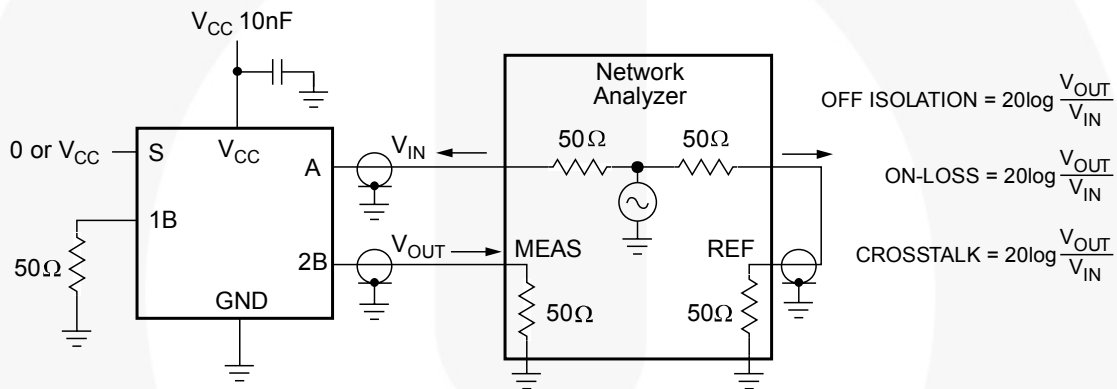


Figure 12. Off Isolation and Crosstalk

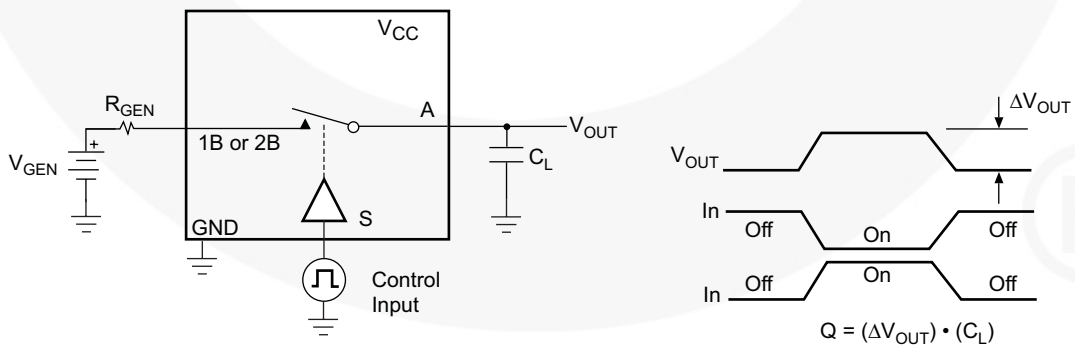


Figure 13. Charge Injection

Test Diagrams (Continued)

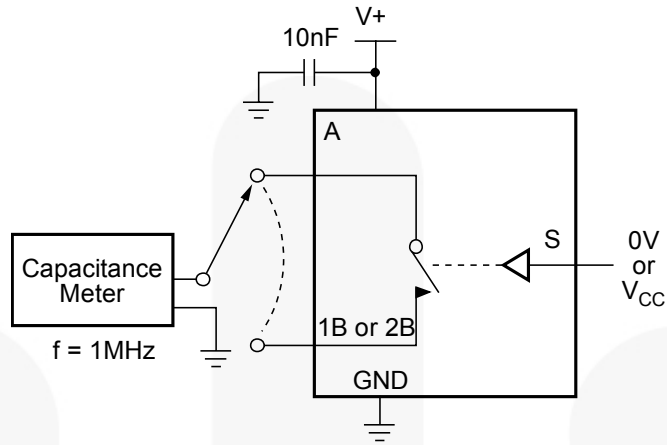


Figure 14. On / Off Capacitance Measurement Setup

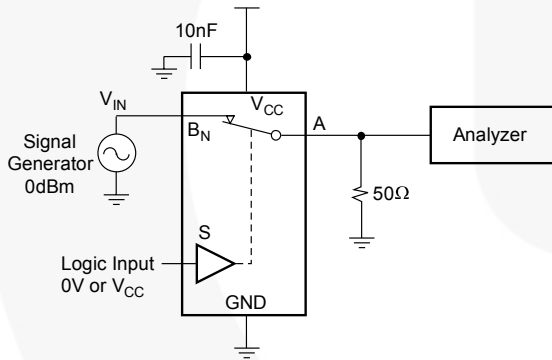


Figure 15. Bandwidth

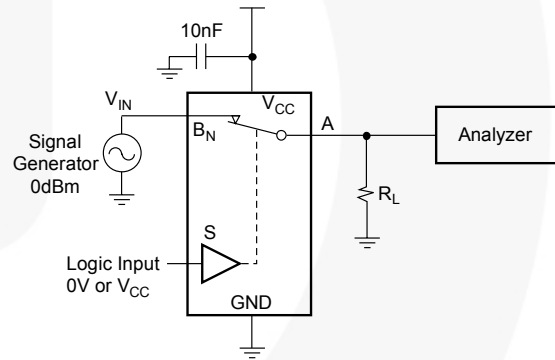
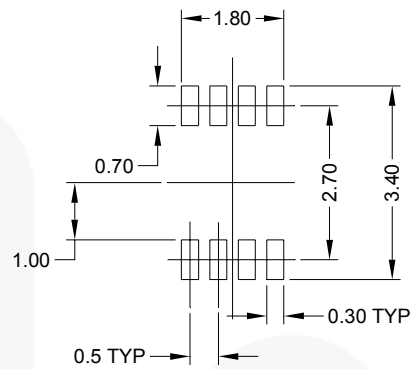
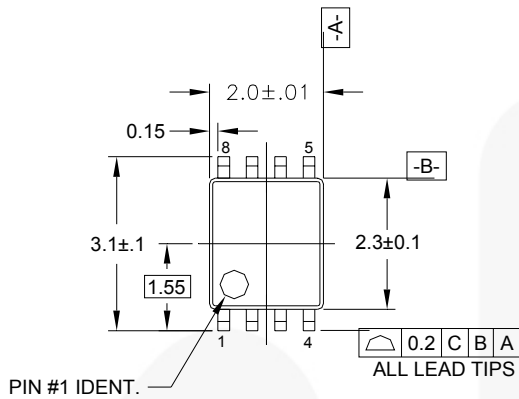
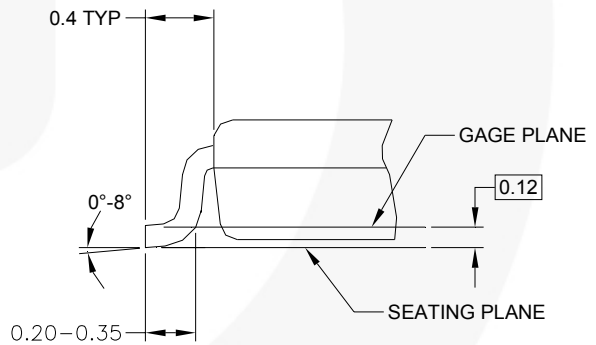
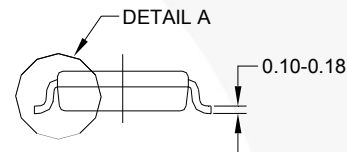
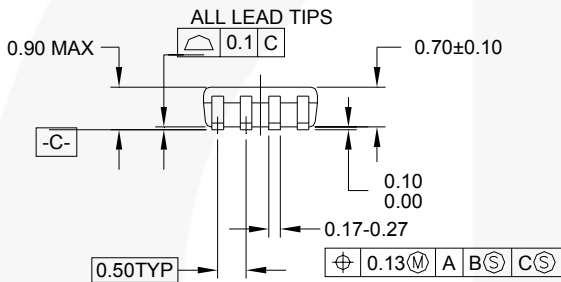


Figure 16. Harmonic Distortion

Physical Dimensions



LAND PATTERN RECOMMENDATION



DETAIL A

NOTES:

- A. CONFORMS TO JEDEC REGISTRATION MO-187
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- D. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M, 1982.

MAB08AREVC

Figure 17. 8-Lead US8, JEDEC MO-187, Variation CA, 3.0mm Wide Package

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

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Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

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